

100V N-Channel Enhancement Mode MOSFET

Description

The 70N10 is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.

General Features

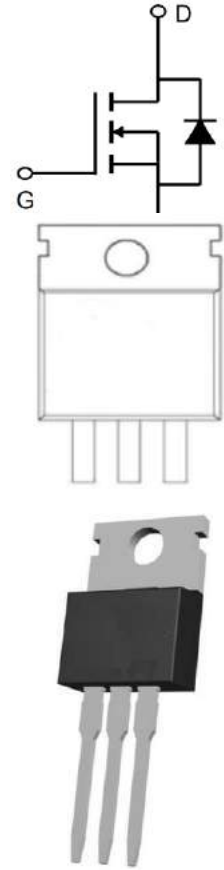
$V_{DS} = 100V, I_D = 70A$

$R_{DS(ON)} < 14m\Omega @ V_{GS} = 10V$

Application

Power amplifier

motor drive



Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
VDSS	Drain-Source Voltage	100	V
ID	Continuous Drain Current	70	A
IDM	Pulsed Drain Current	560	A
VGSS	Gate-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy	2943	mJ
IAR	Avalanche Current	32	A
EAR	Repetitive Avalanche Energy	36	mJ
PD	Power Dissipation (TC = 25°C)	500	W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55 to 175	°C
RthJC	Thermal Resistance, Junction-to-Case	0.75	°C/W
RthJA	Thermal Resistance, Junction-to-Ambient	82	°C/W

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Type	Max	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	100	--	--	V
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 100V, V_{GS} = 0V, T_J = 25^\circ\text{C}$	--	--	1	μA
		$V_{DS} = 80V, V_{GS} = 0V, T_J = 125^\circ\text{C}$	--	--	100	
IGSS	Gate-Source Leakage	$V_{GS} = +20V, V_{DS} = 0V$	--	--	100	nA
		$V_{GS} = -20V, V_{DS} = 0V$	--	--	-100	
VGS(th)	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0	--	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	$V_{GS} = 10V, I_D = 28A$	--	12	14	m Ω
gfs	Forward Transconductance	$V_{DS} = 10V, I_D = 28A$		85		S
Ciss	Input Capacitance	$V_{GS} = 0V,$ $V_{DS} = 25V, f = 1.0\text{MHz}$	--	5600	--	pF
Coss	Output Capacitance		--	610	--	
Crss	Reverse Transfer Capacitance		--	260	--	
Qg	Total Gate Charge	$V_{DD} = 50V, I_D = 28A, V_{GS} = 0$ to 10V	--	60	--	nC
Qgs	Gate-Source Charge		--	15	--	
Qgd	Gate-Drain Charge		--	45	--	
td(on)	Turn-on Delay Time	$V_{DD} = 50V,$ $I_D = 28A,$ $V_{GS} = 10V$ $R_G = 2.5 \Omega$	--	20	--	ns
tr	Turn-on Rise Time		--	28	--	
td(off)	Turn-off Delay Time		--	65	--	
tf	Turn-off Fall Time		--	15	--	
IS	Continuous Body Diode Current	$T_C = 25^\circ\text{C}$	--	--	57	A
ISM	Pulsed Diode Forward Current		--	--	230	
VSD	Body Diode Voltage	$T_J = 25^\circ\text{C}, I_{SD} = 28A, V_{GS} = 0V$	--	--	1.5	V
trr	Reverse Recovery Time	$V_{GS} = 0V, I_S = 28A, di_F/dt = 100A$	--	195	--	ns
Qrr	Reverse Recovery Charge	μs	--	107	--	μC

Notes

- 1、Repetitive Rating: Pulse width limited by maximum junction temperature
- 2、 $I_{AS} = 58A, V_{DD} = 50V, R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$
- 3、Pulse Test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 1\%$

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Typical Characteristics

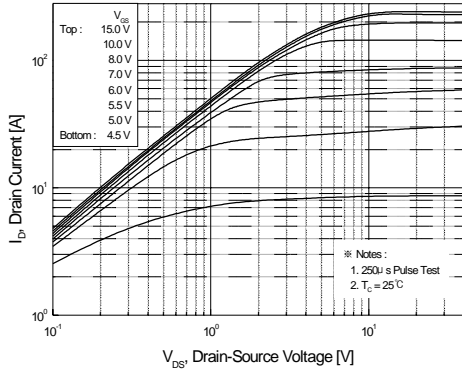


Figure 1. On-Region Characteristics

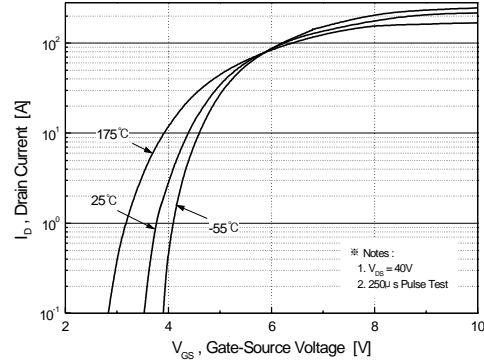


Figure 2. Transfer Characteristics

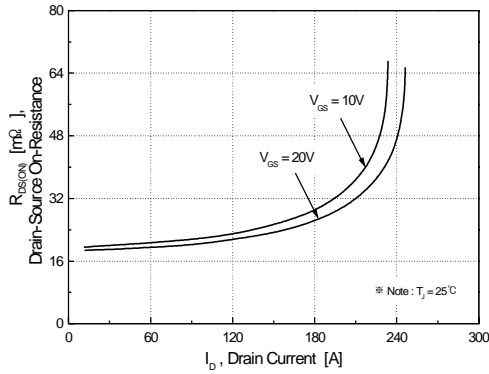


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

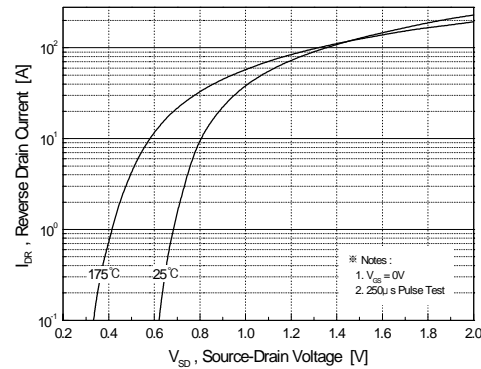


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

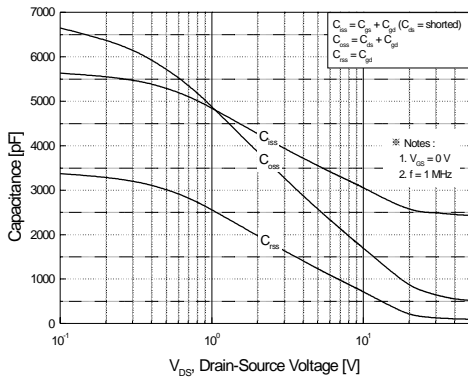


Figure 5. Capacitance Characteristics

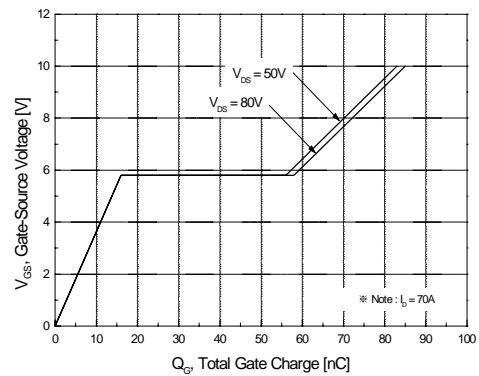


Figure 6. Gate Charge Characteristics

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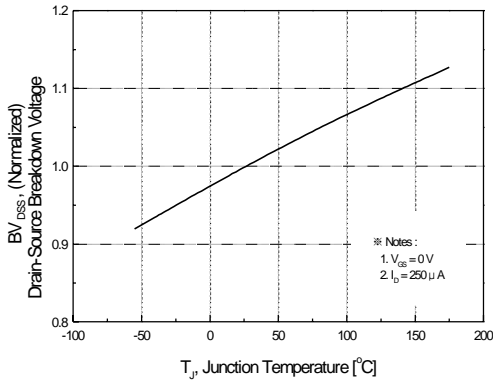


Figure 7. Breakdown Voltage Variation vs. Temperature

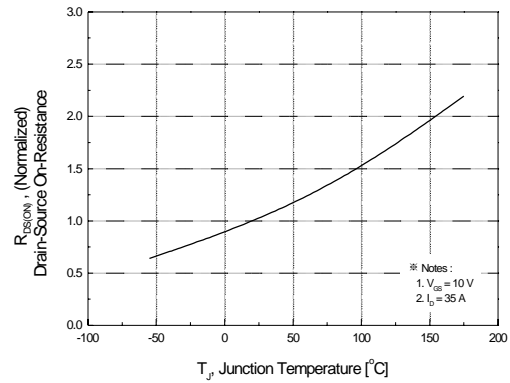


Figure 8. On-Resistance Variation vs. Temperature

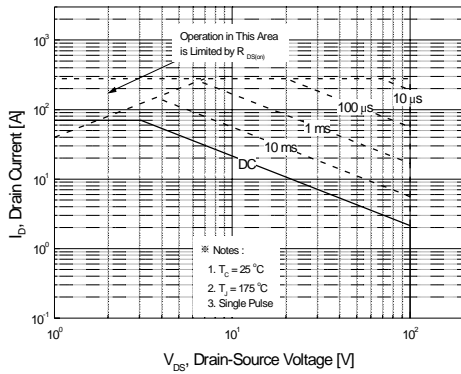


Figure 9. Maximum Safe Operating Area

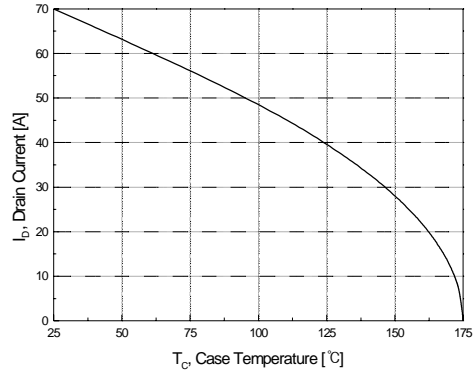


Figure 10. Maximum Drain Current vs. Case Temperature

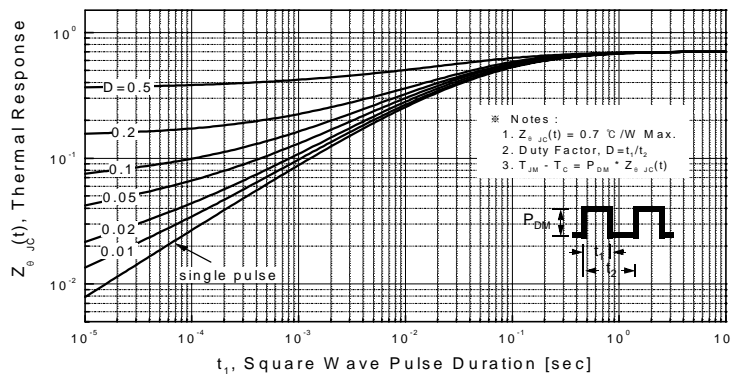
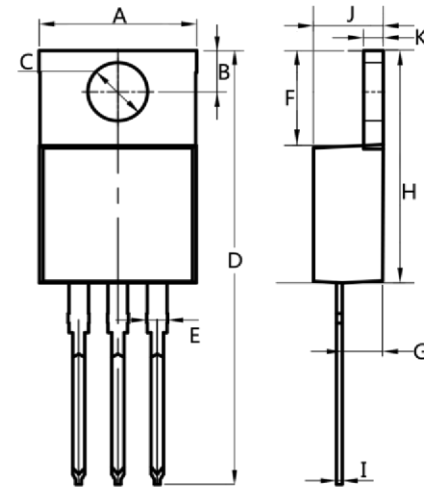


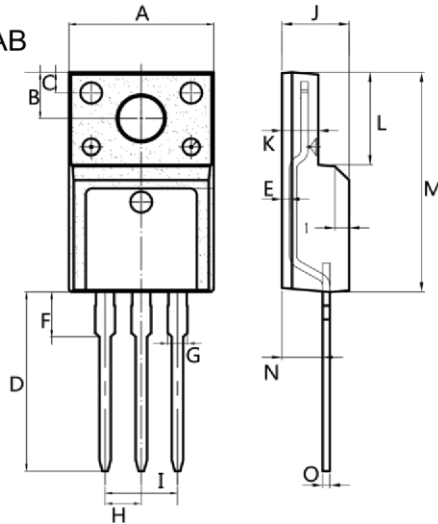
Figure 11. Transient Thermal Response Curve

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TO-220AB


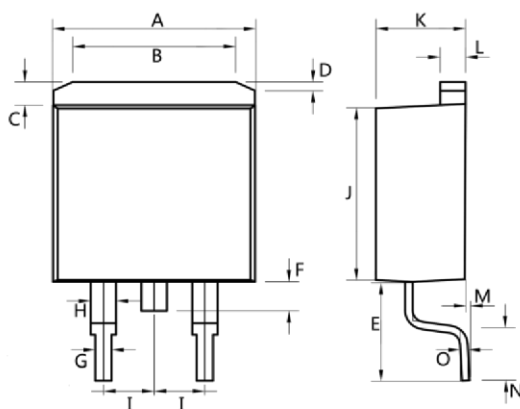
Dim.	Min.	Max.
A	10.0	10.4
B	2.5	3.0
C	3.5	4.0
D	28.0	30.0
E	1.1	1.5
F	6.2	6.6
G	2.9	3.3
H	15.0	16.0
I	0.35	0.45
J	4.3	4.7
K	1.2	1.4

All Dimensions in millimeter

ITO-220AB


Dim.	Min.	Max.
A	9.9	10.3
B	2.9	3.5
C	1.15	1.45
D	12.75	13.25
E	0.55	0.75
F	3.1	3.5
G	1.25	1.45
H	Typ 2.54	
I	Typ 5.08	
J	4.55	4.75
K	2.4	2.7
L	6.35	6.75
M	15.0	16.0
N	2.75	3.15
O	0.45	0.60

All Dimensions in millimeter

TO-263


Dim.	Min.	Max.
A	10.0	10.5
B	7.25	7.75
C	1.3	1.5
D	0.55	0.75
E	5.0	6.0
F	1.4	1.6
G	0.75	0.95
H	1.15	1.35
I	Typ 2.54	
J	8.4	8.6
K	4.4	4.6
L	1.25	1.45
M	0.02	0.1
N	2.4	2.8
O	0.35	0.45

All Dimensions in millimeter